Quad buffer/line driver with 5 V tolerant input/outputs; 3-state

Rev. 1 — 4 April 2013

**Product data sheet** 

### 1. General description

The 74LVC125A-Q100 consists of four non-inverting buffers/line drivers with 3-state outputs (nY) that are controlled by the output enable input (n $\overline{OE}$ ). A HIGH at n $\overline{OE}$  causes the outputs to assume a high-impedance OFF-state.

Inputs can be driven from either 3.3 V or 5 V devices. When disabled, up to 5.5 V can be applied to the outputs.

This product has been qualified to the Automotive Electronics Council (AEC) standard Q100 (Grade 1) and is suitable for use in automotive applications.

## 2. Features and benefits

- Automotive product qualification in accordance with AEC-Q100 (Grade 1)
  - ◆ Specified from -40 °C to +85 °C and from -40 °C to +125 °C
- 5 V tolerant inputs/outputs for interfacing with 5 V logic
- Wide supply voltage range from 2.3 V to 3.6 V
- CMOS low power consumption
- Direct interface with TTL levels
- Complies with JEDEC standard:
  - ◆ JESD8-7A (1.65 V to 1.95 V)
  - ◆ JESD8-5A (2.3 V to 2.7 V)
  - ◆ JESD8-C/JESD36 (2.7 V to 3.6 V)
- ESD protection:
  - MIL-STD-883, method 3015 exceeds 2000 V
  - HBM JESD22-A114F exceeds 2000 V
  - MM JESD22-A115-A exceeds 200 V (C = 200 pF, R = 0 Ω)
- Multiple package options

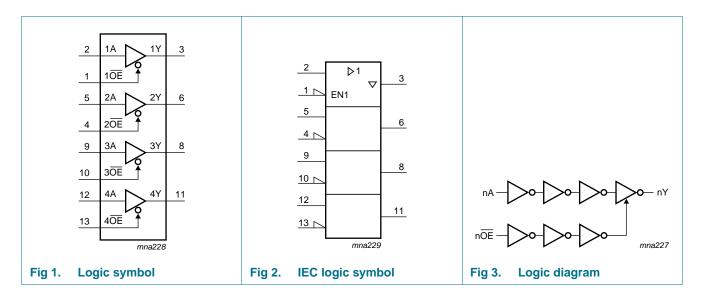


Quad buffer/line driver with 5 V tolerant input/outputs; 3-state

## 3. Ordering information

Type number	Package						
	Temperature range	Name	Description	Version			
74LVC125AD-Q100	–40 °C to +125 °C	SO14	plastic small outline package; 14 leads; body width 3.9 mm; body thickness 1.47 mm	SOT108-1			
74LVC125APW-Q100	–40 °C to +125 °C	TSSOP14	plastic thin shrink small outline package; 14 leads; body width 4.4 mm	SOT402-1			
74LVC125ABQ-Q100	–40 °C to +125 °C	DHVQFN14	plastic dual in-line compatible thermal enhanced very thin quad flat package; no leads; 14 terminals; body $2.5 \times 3 \times 0.85$ mm	SOT762-1			

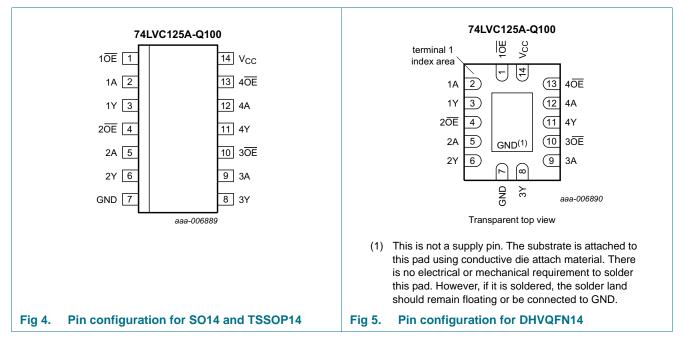
## 4. Functional diagram



Quad buffer/line driver with 5 V tolerant input/outputs; 3-state

## 5. Pinning information

### 5.1 Pinning



### 5.2 Pin description

Table 2. Pin descri	ption	
Symbol	Pin	Description
$1\overline{OE}$ , $2\overline{OE}$ , $3\overline{OE}$ , $4\overline{OE}$	1, 4, 10, 13	data enable input (active LOW)
1A, 2A, 3A, 4A	2, 5, 9, 12	data input
1Y, 2Y, 3Y, 4Y	3, 6, 8, 11	data output
GND	7	ground (0 V)
V <sub>CC</sub>	14	supply voltage

## 6. Functional description

Dis deseriation

#### Table 3.Function selection<sup>[1]</sup>

Inputs nOE	Output	
nOE	nA	nY
L	L	L
L	Н	Н
Н	Х	Z

[1] H = HIGH voltage level; L = LOW voltage level; X = don't care; Z = high-impedance OFF-state

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## 7. Limiting values

#### Table 4. Limiting values

In accordance with the Absolute Maximum Rating System (IEC 60134). Voltages are referenced to GND (ground = 0 V).

					-
Symbol	Parameter	Conditions	Min	Max	Unit
V <sub>CC</sub>	supply voltage		-0.5	+6.5	V
I <sub>IK</sub>	input clamping current	V <sub>1</sub> < 0 V	-50	-	mA
VI	input voltage		<u>[1]</u> –0.5	+6.5	V
I <sub>OK</sub>	output clamping current	$V_{\rm O}$ > $V_{\rm CC}$ or $V_{\rm O}$ < 0 V	-	±50	mA
Vo	output voltage	output HIGH or LOW-state	[2] -0.5	V <sub>CC</sub> + 0.5	V
		output 3-state	[2] -0.5	+6.5	V
lo	output current	$V_{O} = 0 V$ to $V_{CC}$	-	±50	mA
I <sub>CC</sub>	supply current		-	100	mA
I <sub>GND</sub>	ground current		-100	-	mA
P <sub>tot</sub>	total power dissipation	$T_{amb} = -40 \ ^{\circ}C \ to +125 \ ^{\circ}C$	[3] _	500	mW
T <sub>stg</sub>	storage temperature		-65	+150	°C

[1] The minimum input voltage ratings may be exceeded if the input current ratings are observed.

[2] The output voltage ratings may be exceeded if the output current ratings are observed.

For SO14 packages: above 70 °C derate linearly with 8 mW/K.
 For TSSOP14 packages: above 60 °C derate linearly with 5.5 mW/K.
 For DHVQFN14 packages: above 60 °C derate linearly with 4.5 mW/K.

## 8. Recommended operating conditions

#### Table 5. Recommended operating conditions

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Symbol	Parameter	Conditions	Min	Тур	Max	Unit
V <sub>CC</sub>	supply voltage		1.65	-	3.6	V
		functional	1.2	-	-	V
VI	input voltage		0	-	5.5	V
Vo	output voltage	output HIGH or LOW state	0	-	V <sub>CC</sub>	V
		output 3-state	0	-	5.5	V
T <sub>amb</sub>	ambient temperature		-40	-	+125	°C
$\Delta t / \Delta V$	input transition rise and fall rate	$V_{CC}$ = 2.3 V to 2.7 V	0	-	20	ns/V
		$V_{CC} = 2.7 V \text{ to } 3.6 V$	0	-	10	ns/V

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## 9. Static characteristics

#### Table 6. Static characteristics

At recommended operating conditions. Voltages are referenced to GND (ground = 0 V).

Symbol	Parameter	Conditions	-40 °	°C to +8	35 °C	–40 °C to +125 °C		Unit	
			Min	Typ[1]	Max	Min	Max		
ViH	HIGH-level	V <sub>CC</sub> = 1.2 V	1.08	-	-	1.08	-	V	
input voltage	$V_{CC}$ = 1.65 V to 1.95 V	$0.65 \times V_{CC}$	-	-	$0.65 \times V_{CC}$	-	V		
	$V_{CC}$ = 2.3 V to 2.7 V	1.7	-	-	1.7	-	V		
		$V_{CC}$ = 2.7 V to 3.6 V	2.0	-	-	2.0	-	V	
/ <sub>IL</sub>	LOW-level input	V <sub>CC</sub> = 1.2 V	-	-	0.12	-	0.12	V	
	voltage	$V_{CC}$ = 1.65 V to 1.95 V	-	-	$0.35 \times V_{CC}$	-	$0.35 \times V_{CC}$	V	
		$V_{CC}$ = 2.3 V to 2.7 V	-	-	0.7	-	0.7	V	
		$V_{CC}$ = 2.7 V to 3.6 V	-	-	0.8	-	0.8	V	
/ <sub>ОН</sub>	HIGH-level	$V_{I} = V_{IH} \text{ or } V_{IL}$							
	output voltage	$I_{O} = -100 \ \mu A;$ $V_{CC} = 1.65 \ V \text{ to } 3.6 \ V$	$V_{CC}-0.2$	-	-	$V_{CC}-0.3$	-	V	
		$I_{O} = -4 \text{ mA}; V_{CC} = 1.65 \text{ V}$	1.2	-	-	1.05	-	V	
		$I_{O} = -8 \text{ mA}; V_{CC} = 2.3 \text{ V}$	1.8	-	-	1.65	-	V	
		$I_{O} = -12 \text{ mA}; V_{CC} = 2.7 \text{ V}$	2.2	-	-	2.05	-	V	
		$I_{O} = -18 \text{ mA}; V_{CC} = 3.0 \text{ V}$	2.4	-	-	2.25	-	V	
		$I_{O} = -24 \text{ mA}; V_{CC} = 3.0 \text{ V}$	2.2	-	-	2.0	-	V	
/ <sub>OL</sub>	LOW-level	$V_{I} = V_{IH} \text{ or } V_{IL}$							
	output voltage	I <sub>O</sub> = 100 μA; V <sub>CC</sub> = 1.65 V to 3.6 V	-	-	0.2	-	0.3	V	
		I <sub>O</sub> = 4 mA; V <sub>CC</sub> = 1.65 V	-	-	0.45	-	0.65	V	
		$I_{O}$ = 8 mA; $V_{CC}$ = 2.3 V	-	-	0.6	-	0.8	V	
		$I_0$ = 12 mA; $V_{CC}$ = 2.7 V	-	-	0.4	-	0.6	V	
		$I_0 = 24 \text{ mA}; V_{CC} = 3.0 \text{ V}$	-	-	0.55	-	0.8	V	
I	input leakage current	$V_{CC}$ = 3.6 V; $V_{I}$ = 5.5 V or GND	-	±0.1	±5	-	±20	μA	
OZ	OFF-state output current	$      V_{I} = V_{IH} \text{ or } V_{IL}; V_{CC} = 3.6 \text{ V};                                   $	-	±0.1	±5	-	±20	μA	
OFF	power-off leakage current	$V_{CC}$ = 0.0 V; V <sub>I</sub> or V <sub>O</sub> = 5.5 V	-	±0.1	±10	-	±20	μA	
СС	supply current	$\label{eq:V_CC} \begin{array}{l} V_{CC} = 3.6 \ V; \ V_{I} = V_{CC} \ \text{or GND}; \\ I_{O} = 0 \ A \end{array}$	-	0.1	10	-	40	μA	
Al <sub>CC</sub>	additional supply current	per input pin; V_I = V_{CC} - 0.6 V; I_O = 0 A; V_{CC} = 2.7 V to 3.6 V	-	5	500	-	5000	μA	
2	input capacitance	$V_{CC} = 0 V$ to 3.6 V; V <sub>I</sub> = GND to V <sub>CC</sub>	-	4.0	-	-	-	pF	

[1] All typical values are measured at V<sub>CC</sub> = 3.3 V (unless stated otherwise) and T<sub>amb</sub> = 25 °C.

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## **10.** Dynamic characteristics

#### Table 7. Dynamic characteristics

Voltages are referenced to GND (ground = 0 V). For test circuit see Figure 8.

Symbol	Parameter	Conditions		–40 °C to +85 °C			-40 °C to +125 °C		Unit
- ,			-	Min	Typ[1]	Max	Min	Max	
t <sub>pd</sub>	propagation delay	nA to nY; see <u>Figure 6</u>	[2]		••		I	l	
		V <sub>CC</sub> = 1.2 V		-	12.0	-	-	-	ns
		$V_{CC}$ = 1.65 V to 1.95 V		1.5	5.4	11.0	1.5	12.8	ns
		$V_{CC}$ = 2.3 V to 2.7 V		1.0	2.9	5.7	1.0	6.7	ns
		$V_{CC} = 2.7 V$		1.5	2.8	5.5	1.5	7.0	ns
		$V_{CC}$ = 3.0 V to 3.6 V		1.0	2.5	4.8	1.0	6.0	ns
t <sub>en</sub>	enable time	nOE to nY; see Figure 7	[2]						
		V <sub>CC</sub> = 1.2 V		-	16.0	-	-	-	ns
		$V_{CC}$ = 1.65 V to 1.95 V		1.0	5.0	12.2	1.0	14.2	ns
		$V_{CC}$ = 2.3 V to 2.7 V		0.5	2.9	6.8	0.5	7.9	ns
		$V_{CC} = 2.7 V$		1.5	3.1	6.6	1.5	8.5	ns
		$V_{CC}$ = 3.0 V to 3.6 V		1.0	2.3	5.4	1.0	7.0	ns
t <sub>dis</sub>	disable time	nOE to nY; see Figure 7	[2]						
		V <sub>CC</sub> = 1.2 V		-	7.0	-	-	-	ns
		$V_{CC}$ = 1.65 V to 1.95 V		2.2	4.6	7.5	2.2	8.7	ns
		$V_{CC}$ = 2.3 V to 2.7 V		0.5	2.6	4.2	0.5	5.0	ns
		$V_{CC} = 2.7 V$		1.5	3.1	5.0	1.5	6.5	ns
		$V_{CC}$ = 3.0 V to 3.6 V		1.0	3.2	4.6	1.0	6.0	ns
t <sub>sk(o)</sub>	output skew time	$V_{CC} = 3.0 \text{ V} \text{ to } 3.6 \text{ V}$	[3]	-	-	1.0	-	1.5	ns
C <sub>PD</sub>	power dissipation	per buffer; $V_I = GND$ to $V_{CC}$	[4]						
	capacitance	$V_{CC}$ = 1.65 V to 1.95 V		-	6.0	-	-	-	pF
		$V_{CC}$ = 2.3 V to 2.7 V		-	9.4	-	-	-	pF
		$V_{CC} = 3.0 \text{ V} \text{ to } 3.6 \text{ V}$		-	12.4	-	-	-	pF

[1] Typical values are measured at  $T_{amb}$  = 25 °C and  $V_{CC}$  = 1.2 V, 1.8 V, 2.5 V, 2.7 V, and 3.3 V respectively.

[2]  $t_{pd}$  is the same as  $t_{PLH}$  and  $t_{PHL}$ .

 $t_{en}$  is the same as  $t_{PZL}$  and  $t_{PZH}$ .

 $t_{\text{dis}}$  is the same as  $t_{\text{PLZ}}$  and  $t_{\text{PHZ}}.$ 

[3] Skew between any two outputs of the same package switching in the same direction. This parameter is guaranteed by design.

[4]  $C_{PD}$  is used to determine the dynamic power dissipation ( $P_D$  in  $\mu W$ ).

 $P_{D} = C_{PD} \times V_{CC}^{2} \times f_{i} \times N + \Sigma (C_{L} \times V_{CC}^{2} \times f_{o}) \text{ where:}$ 

 $f_i$  = input frequency in MHz;  $f_o$  = output frequency in MHz

 $C_{\text{L}}$  = output load capacitance in pF

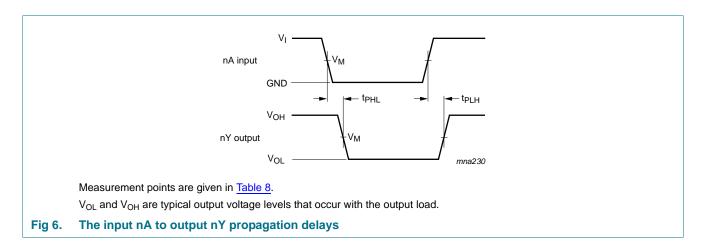
V<sub>CC</sub> = supply voltage in Volts

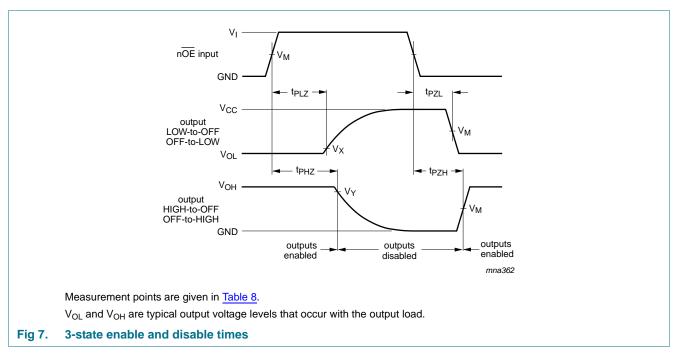
N = number of inputs switching

 $\Sigma(C_L \times V_{CC}{}^2 \times f_o)$  = sum of the outputs.

Quad buffer/line driver with 5 V tolerant input/outputs; 3-state

## 11. AC waveforms



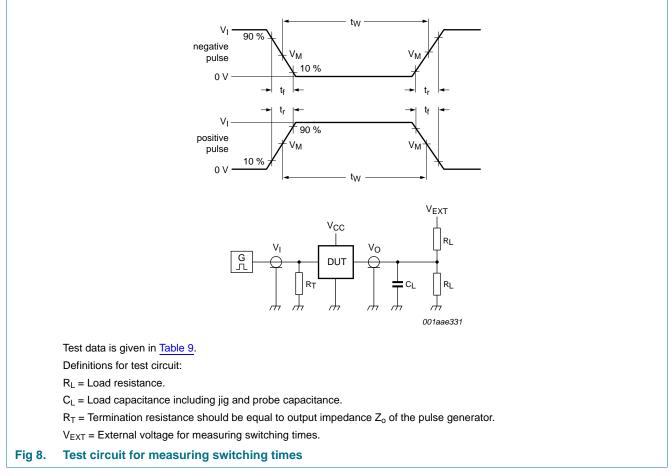


#### Table 8. Measurement points

Supply voltage	Input		Output
V <sub>CC</sub>	VI	V <sub>M</sub>	V <sub>M</sub>
1.2 V	V <sub>CC</sub>	$0.5  imes V_{CC}$	$0.5  imes V_{CC}$
1.65 V to 1.95 V	V <sub>CC</sub>	$0.5  imes V_{CC}$	$0.5  imes V_{CC}$
2.3 V to 2.7 V	V <sub>CC</sub>	$0.5  imes V_{CC}$	$0.5  imes V_{CC}$
2.7 V	2.7 V	1.5 V	1.5 V
3.0 V to 3.6 V	2.7 V	1.5 V	1.5 V

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#### Quad buffer/line driver with 5 V tolerant input/outputs; 3-state

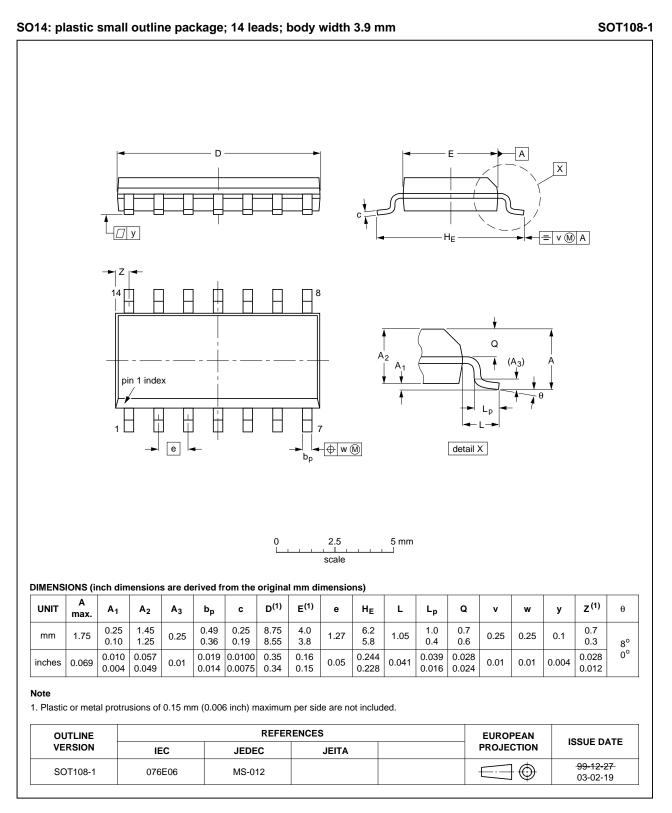


Supply voltage	Input	Input		Load		V <sub>EXT</sub>		
	VI	t <sub>r</sub> , t <sub>f</sub>	CL	RL	t <sub>PLH</sub> , t <sub>PHL</sub>	t <sub>PLZ</sub> , t <sub>PZL</sub>	t <sub>PHZ</sub> , t <sub>PZH</sub>	
1.2 V	V <sub>CC</sub>	$\leq$ 2 ns	30 pF	1 kΩ	open	$2 \times V_{CC}$	GND	
1.65 V to 1.95 V	V <sub>CC</sub>	$\leq$ 2 ns	30 pF	1 kΩ	open	$2\times V_{CC}$	GND	
2.3 V to 2.7 V	V <sub>CC</sub>	$\leq$ 2 ns	30 pF	500 Ω	open	$2\times V_{CC}$	GND	
2.7 V	2.7 V	$\leq$ 2.5 ns	50 pF	500 Ω	open	$2 \times V_{CC}$	GND	
3.0 V to 3.6 V	2.7 V	≤ 2.5 ns	50 pF	500 Ω	open	$2 \times V_{CC}$	GND	

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Quad buffer/line driver with 5 V tolerant input/outputs; 3-state

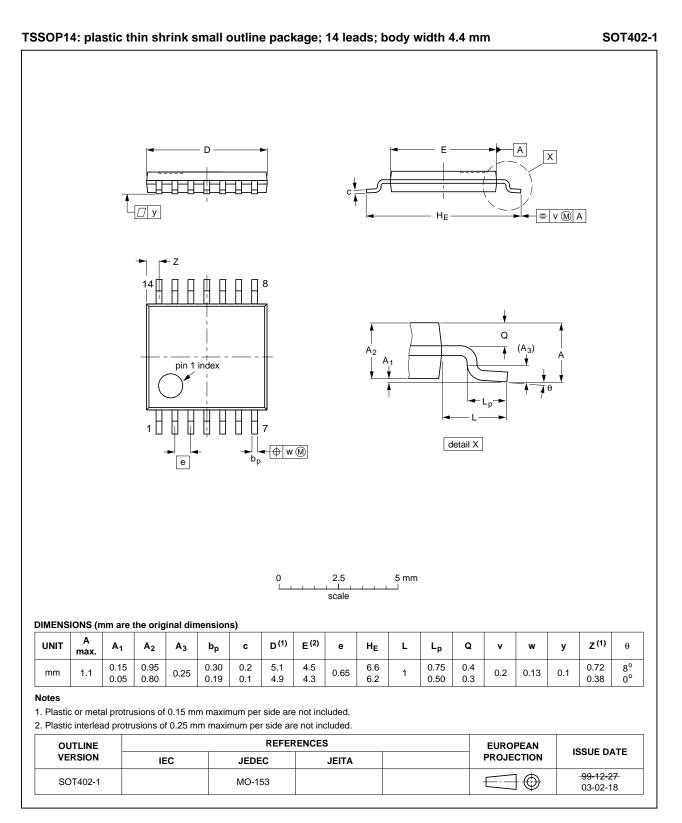
## 12. Package outline



#### Fig 9. Package outline SOT108-1 (SO14)

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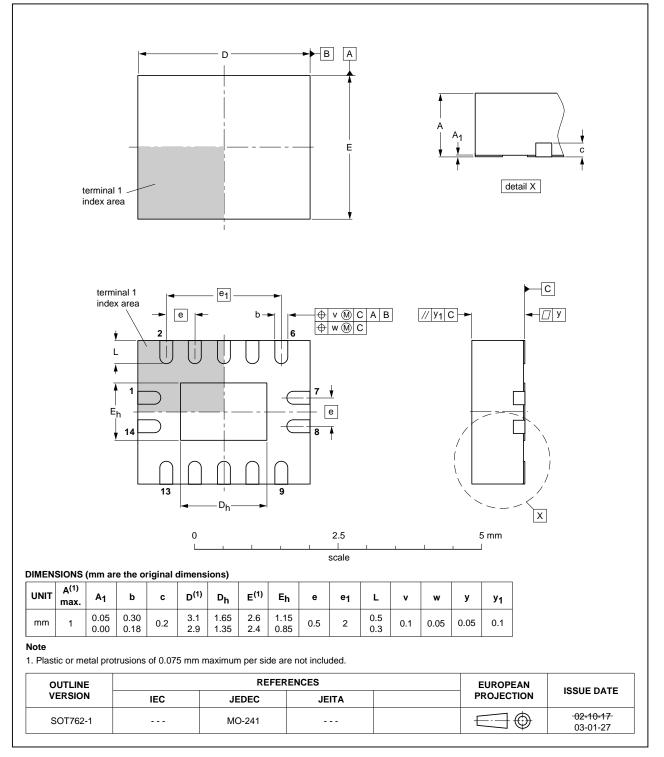
Quad buffer/line driver with 5 V tolerant input/outputs; 3-state



#### Fig 10. Package outline SOT402-1 (TSSOP14)

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DHVQFN14: plastic dual in-line compatible thermal enhanced very thin quad flat package; no leads; 14 terminals; body 2.5 x 3 x 0.85 mm SOT762-1

#### Fig 11. Package outline SOT762-1 (DHVQFN14)

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Quad buffer/line driver with 5 V tolerant input/outputs; 3-state

## **13. Abbreviations**

Table 10.	Abbreviations
Acronym	Description
CDM	Charged Device Model
DUT	Device Under Test
ESD	ElectroStatic Discharge
MIL	Military
MM	Machine Model
HBM	Human Body Model
TTL	Transistor-Transistor Logic

## 14. Revision history

Table 11. Revision history					
Document ID	Release date	Data sheet status	Change notice	Supersedes	
74LVC125A_Q100 v.1	20130404	Product data sheet	-	-	

Quad buffer/line driver with 5 V tolerant input/outputs; 3-state

## **15. Legal information**

#### 15.1 Data sheet status

Document status[1][2]	Product status <sup>[3]</sup>	Definition
Objective [short] data sheet	Development	This document contains data from the objective specification for product development.
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#### Quad buffer/line driver with 5 V tolerant input/outputs; 3-state

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## 74LVC125A-Q100

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